

# SK 95 D 16p



SEMITOP® 2 Press-Fit

## Bridge Rectifier

### SK 95 D 16p

#### Features

- Compact design
- One screw mounting
- Solder free mounting with Press-Fit terminals
- Fully compatible with SEMITOP® Press-Fit types
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DBC)
- High surge currents
- Glass passivated diode chips
- UL recognized, file no. E 63 532

#### Typical Applications\*

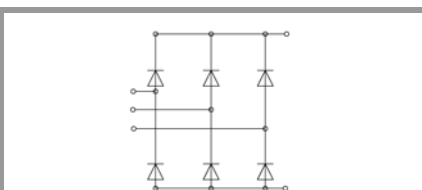
- Input rectifier for power supplies
- Rectifier

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
<b>Rectifier</b>				
$V_{RSM}$	$T_j = 25\text{ °C}$		1700	V
$V_{RRM}$	$T_j = 25\text{ °C}$		1600	V
$I_D$	$T_j = 150\text{ °C}$	$T_s = 25\text{ °C}$	137	A
		$T_s = 70\text{ °C}$	104	A
$I_{FSM}$	sin 180° 10 ms	$T_j = 25\text{ °C}$	635	A
		$T_j = 150\text{ °C}$	560	A
$i^2t$	sin 180° 10 ms	$T_j = 25\text{ °C}$	2016	A <sup>2</sup> s
		$T_j = 150\text{ °C}$	1568	A <sup>2</sup> s
$T_j$			-40 ... 150	°C

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
<b>Module</b>				
$I_{t(RMS)}$	$T_{terminal} = 100\text{ °C}, T_s = 60\text{ °C}$		40	A
$T_{stg}$			-40 ... 125	°C
$V_{isol}$	AC, sinusoidal, t = 1 min		2500	V

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
<b>Rectifier</b>						
$V_F$	$I_F = 25\text{ A}$	$T_j = 25\text{ °C}$		1.00	1.21	V
		chipelevel $T_j = 125\text{ °C}$		0.90	1.10	V
$V_{F0}$	chipelevel	$T_j = 25\text{ °C}$		0.88	0.98	V
		$T_j = 125\text{ °C}$		0.73	0.83	V
$r_F$	chipelevel	$T_j = 25\text{ °C}$		4.8	9.2	mΩ
		$T_j = 125\text{ °C}$		6.8	11	mΩ
$I_R$	$T_j = 145\text{ °C}, V_{RRM}$				1.1	mA
$R_{th(j-s)}$	per Diode			1.2		K/W

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
<b>Module</b>						
$M_s$	to heatsink		1.8		2	Nm
w	weight			19		g



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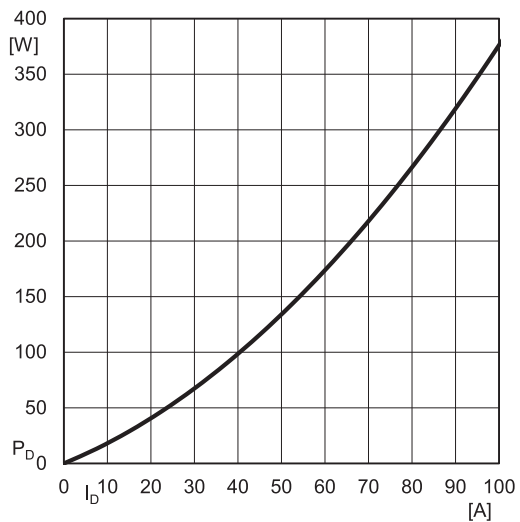


Fig. 1: Power dissipation vs. Output current

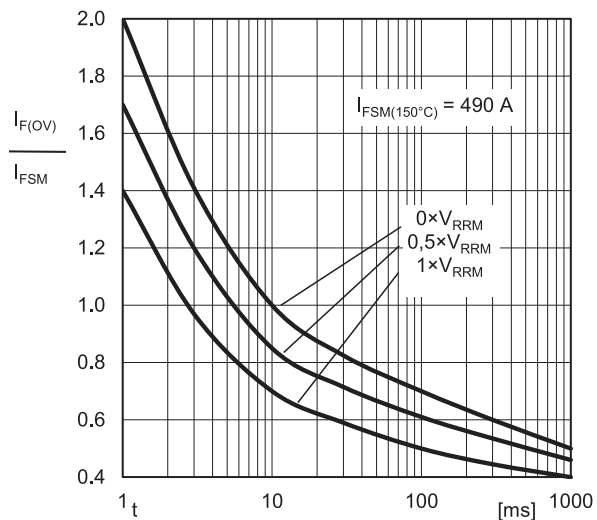


Fig. 2: Surge overload current vs time

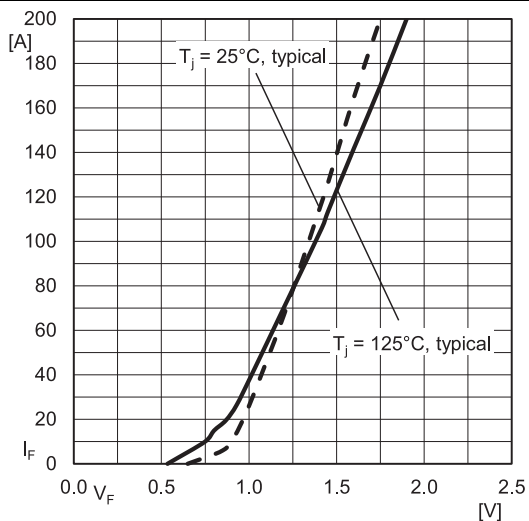


Fig. 3: Forward characteristic of single diode

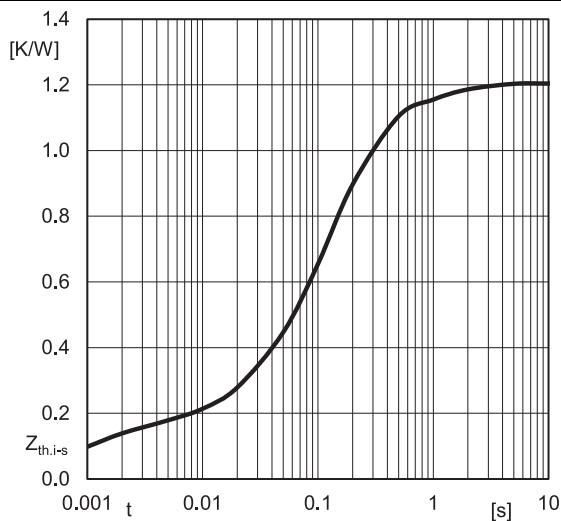
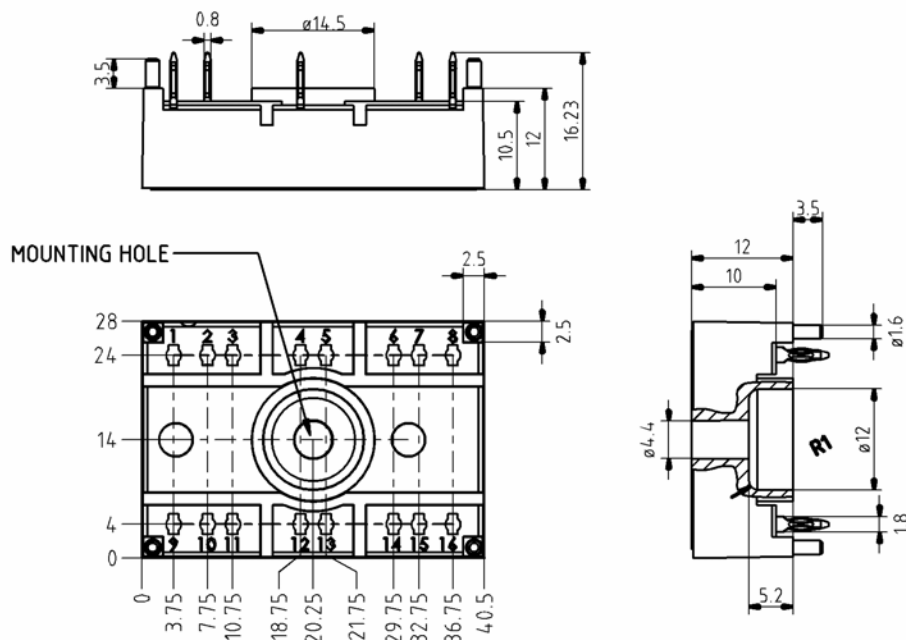


Fig. 4: Transient thermal impedance vs. time

dimensions in mm  
tolerance system: ISO 2768-m



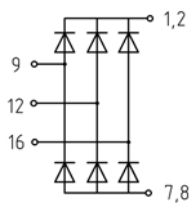
Suggested drilled hole diameter for terminal pins in the circuit board:

- minimum: 1,575mm
- typical: 1,6mm
- maximum: 1,625mm

Suggested hole diameter for the mounting pins in the circuit board: 2mm

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SEMITOP 2 Press-Fit



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

## **\*IMPORTANT INFORMATION AND WARNINGS**

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